Supplementary Materials

Experimental Section

Materials

Titanium tetrachloride(TiCl₄, 99.9%), Tetrabutyl titanate (98%) were acquired from Sinopharm Chemical Reagent Co., Ltd. Methylammonium Chloride(MACl $, \geq$ 99.5%), methylammonium bromide (MABr $, \geq$ 99.5%), Methylammonium Iodide(MAI $, \geq$ 99.5%) were purchased from Xi'an Polymer Light Technology Corp. Caesium bromide (CsBr, 99.5%), Silver bromide (AgBr, 98%), Bismuth(III) bromide (BiBr₃, \geq 98%), dimethylsulfoxide (DMSO) and chlorobenzene (CB) were obtained from Macklin. All chemicals were used without further purification.

Device fabrication

The TiO₂ dense layer was obtained by thermal deposition at 70°C in water bath with 0.1M TICl₄ solution. After annealing at 450°C, it was put into the tank of the reaction kettle containing tetrabutyl titanate solution to react with 110 minutes. TiO₂ nanorods were prepared by annealing at 450 °C for 30 minutes. The concentration of Cs₂AgBiBr₆ precursor solution is 0.5M. CsBr, AgBr and BiBr₃ were added to DMSO at a molar mass of 2:1:1 and stirred at 70°C for more than 10 hours. Double perovskite precursor solution was obtained after filtration. The FTO/TiO₂ substrate was preheated to 10 minutes at 70°C and then spin-cast by perovskite precursor solution followed by spin-coating of antisolvent CB. After annealing at 280°C for 10 minutes, Cs₂AgBiBr₆ perovskite films were obtained. As for Cs₂AgBiBr₆-MAX, MAX solution was spin-cast before spin-coating of perovskite precursor solution. The concentration ratio of perovskite precursor/MAX is set at 2:1. After finishing the growth of

 TiO_2 NRs, 0.25M-MAX solution was spin-coated in advance on the TiO_2 ETL followed by spin-coating $Cs_2AgBiBr_6$ precursor. 0.25mmol MACl, MABr and MAI were dissolved separately in DMSO to prepare MAX solution. The entire preparation procedure of $Cs_2AgBiBr_6$ film was carried out in airing chamber. The low temperature carbon paste was coated on the perovskite layer by screen printing, and heat-treated at 100°C for 10 minutes to obtain carbon based electrode. The active area of the device is ~0.06cm².

Characterization

Crystalline structures were tested by an X-Ray Diffractometer (XRD, Brucker D8). The topview and cross-sectional morphologies were investigated by SEM (JEOL JSM-7100F). The chemical bonding was recorded by XPS spectrometer (Thermo scientific, ESCAlab 250xi). The absorption curves were collected by a UV–vis-NIR spectrophotometer (UV-3600, Shimadzu). The photoluminescence spectroscopy measurements were measured with a fluorescence spectrophotometer (FLS 1000). The Fourier transform infrared (FTIR) spectra were obtained by Vacuum Fourier Transform Infrared Spectroscopy of Brooke Company in G ermany (VERTEX 70v). The J-V curves of PeSCs were finished with the American Newport Oriel test system (forward scan parameters: 1.5V to 0V, step length 0.02V; reverse scan parameters: 0V to 1.5V, step length 0.02V). The sunlight intensity was calibrated with a certified reference silicon solar cell. The EQE was measured by Keithley 2400 source meter and solar simulator (Newport 67005) under standard AM 1.5G illumination. The EIS measurement was conducted by an electrochemical station (CHI760e).

Supporting tables

Samples	A ₁	$\tau_1(ns)$	A ₂	$\tau_2(ns)$	τ
Reference	0.996	45.83	0.035	166.34	59.46
MACl	0.699	1.74	0.281	46.34	42.53
MABr	0.530	3.25	0.402	52.25	48.53
MAI	0.646	2.43	0.359	48.81	45.00

Table S1 PL decay parameters of $TiO_2/Cs_2AgBiBr_6$ films.

TRPL spectra of $TiO_2/Cs_2AgBiBr_6$ films were fitted by the following formula^[1].

$$y = y_0 + A_1 e^{-\left(\frac{x}{\tau_1}\right)} + A_2 e^{-\left(\frac{x}{\tau_2}\right)}$$
(1)

Where τ_1 and τ_2 are the fast decay time related to defects and slow decay time related to bimolecular recombination, respectively, and A_1 and A_2 are amplitudes. The carrier recombination lifetime (τ) was calculated by the formula:

$$\tau = \frac{A_1 \tau_1^2 + A_2 \tau_2^2}{A_1 \tau_1 + A_2 \tau_2} \tag{2}$$

Cs ₂ AgBiH	Br ₆ Samples	Voc (V)	Jsc(mA cm ⁻²)	FF (%)	PCE (%)	HI
	FW	1.10	2.17	45	1.08	
Referen	ce RE	1.06	2.29	50	1.20	0.17
	Ave.	1.05±0.0 5	1.92±0.44	46±5.48	1.01±0.19	
	FW	1.09	3.05	59	1.96	
MACI	RE	1.07	3.04	62	2.03	0.05
	Ave.	1.06±0.0 5	2.94±0.11	60±3.43	1.92±0.11	
	FW	1.06	2.34	59	1.46	
MABr	RE	1.01	2.57	59	1.55	0.12
	Ave.	1.07±0.0 6	2.29±0.25	53±6.97	1.34±0.21	
	FW	1.05	2.51	62	1.66	
MAI	RE	1.03	2.79	63	1.80	0.1 1
	Ave.	$1.08{\pm}0.0$ 7	2.66±0.14	59±4.18	1.51±0.29	

Table S2 Photovoltaic parameters of the best $Cs_2AgBiBr_6$ PeSCs with and without MAX pre-treatment.

Table S3 Rs, Rct and C fitted by nyquist EIS diagram.

Sample	Rs(KΩ)	Rct(KΩ)	C(F)
Reference	76.34	1.993	4.004E-8
MACI	70.05	1.272	2.940E-8
MABr	71.23	1.507	5.275E-9
MAI	71.78	1.360	4.242E-8

	Table S4	Rsh, Rs	and J ₀	derived	from	dark J-V	curves
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Sample	Rsh(Ω cm ²)	Rs(Ω cm ²)	lnJ ₀	J ₀ (mA cm ⁻²)
Reference	7.07E7	71.38	-10.41	3.01 <i>E</i> -5
MACl	6.85E6	94.76	-13.60	$1.24^{E}-6$
MABr	2.06 ^E 6	92.69	-11.40	$1.12^{E}-5$
MAI	$1.60^{E_{6}}$	84.47	-12.47	3.84 <i>E</i> -6

The dark current fitting of the device was according to the following formula ^[2, 3].

$$-\frac{dV}{dJ} = \frac{AK_BT}{e} \frac{1}{(J_{sc} - J)} + Rs$$

$$\ln (J_{sc} - J) = \frac{e}{AK_BT}(V + Rs * J) + \ln J_0$$
(3)
(4)

Here A is the ideal factors of the diode, R_S is the series resistance, R_{SH} is the shunt resistance, and J_0 reverse saturation current. K_B is the Boltzmann constant, T is the absolute temperature, e is the basic charge, and V is the DC bias voltage applied to the cell.

Samples	Days	V _{oc} (V)	J _{sc} (mA cm ⁻²)	FF (%)	PCE (%)
	0	1.06	2.29	50	1.20
	5	1.07	2.26	49	1.19
Deference	10	1.08	2.23	47	1.12
Kelerence	15	1.09	2.23	46	1.12
MACI	20	1.10	2.17	46	1.10
	30	1.19	1.89	44	1.00
	0	1.07	3.04	62	2.03
	5	1.09	2.99	61	2.01
	10	1.15	2.99	58	2.00
	15	1.13	3.00	58	1.97
	20	1.13	2.98	57	1.93
	30	1.22	2.61	58	1.85

Table S5 Photovoltaic parameters of the champion devices stored within 30 days.

Supporting Figures



Fig.S1 (a) Diagrammatic sketch for preparation process of Cs₂AgBiBr₆ films with MAX pre-

treatment (X is Cl⁻, Br⁻ and I⁻).



Fig. S2 (a) XRD patterns and (220) diffraction peaks of perovskite films. The FWHM value is measured for (220) plane. (b) UV-vis absorption spectra of $Cs_2AgBiBr_6$ perovskite films. (c) PL and (d)TRPL spectra of $Cs_2AgBiBr_6$ perovskite films.

The bandgap of Cs₂AgBiBr₆ films was determined by Tauc curve equation.

$$(\alpha h v)^{\varphi n} = A(hv - E_g)$$
(1)

Where α represents the absorption coefficient, h is the Planck constant and v is the incident frequency, A is a proportional constant^[4, 5].



Fig. S3 XPS spectra of Cs 3d, Ag 3d, Bi 4f and Br 3d in reference films treated and

Cs₂AgBiBr₆-MACl films.



Fig.S4 Survey X-ray photoelectron spectroscopy (XPS) spectra of the reference and Cs2AgBiBr6-

MACl.



Fig.S5 Fourier transform infrared spectrometer (FT-IR) spectra of Cs₂AgBiBr₆ samples



Fig.S6 Steady-state power outputs at the maximum power point of (a) $Cs_2AgBiBr_6$ -MABr and (b)

Cs₂AgBiBr₆-MAI.



Fig.S7 Schematic diagram and dark I-V curves of Cs₂AgBiBr₆ devices.

The space-charge limited current (SCLC) model was used to calculate the trap density (N_{trap}).

$$N_{t r} = \frac{2 \varepsilon_0 V_{T F}}{p eL^2}$$
(5)

Where e, L, ε and ε_0 are the basic charge, the thickness of the active layer, the relative permittivity of $Cs_2AgBiBr_6$ and the vacuum dielectric constant (8.8542 × 10⁻¹⁴ F/cm), respectively.^[6, 7] The trapfilled limit voltage (V_{TFL}) was 1.04V, 0.69V, 0.93V and 0.90V, producing N_{trap} was 1.468 × 10¹⁵ cm⁻³, 9.737 × 10¹⁴ cm⁻³, 1.312 × 10¹⁵ cm⁻³ and 1.27 × 10¹⁵ cm⁻³ for the reference Cs₂AgBiBr₆, Cs₂AgBiBr₆-MACl, Cs₂AgBiBr₆-MABr and Cs₂AgBiBr₆-MAI devices, respectively.



Fig.S8 J-V curves of Cs₂AgBiBr₆ PeSCs in dark.



Fig.S9 J-V curves of Cs₂AgBiBr₆ devices pre-treated with different concentration MACl.

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